BGA612

Silicon Germanium Broadband MMIC Amplifier

RF & Protection Devices



Edition 2011-09-02

Published by Infineon Technologies AG, 81726 München, Germany
© Infineon Technologies AG 2011.
All Rights Reserved.

Attention please!

The information herein is given to describe certain components and shall not be considered as a guarantee of characteristics.

Terms of delivery and rights to technical change reserved.

We hereby disclaim any and all warranties, including but not limited to warranties of non-infringement, regarding circuits, descriptions and charts stated herein.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.



BGA612, Silicon Germanium Broadband MMIC Amplifier

Revision History: 2011-09-02, Rev. 2.1

Previous Version: 2003-11-04

Page	Subjects (major changes since last revision)			
All	New Chip Version with integrated ESD protection			
5	Electrical Characteristics slightly changed			
7-8	Figures updated			
All	Document layout change			

Trademarks

SIEGET® is a registered trademark of Infineon Technologies AG.

Data Sheet 3 Rev. 2.1, 2011-09-02



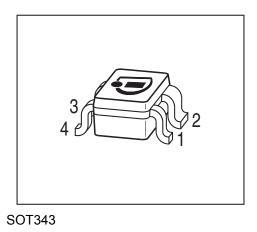
Silicon Germanium Broadband MMIC Amplifier

1 Silicon Germanium Broadband MMIC Amplifier

Feature

- Cascadable 50 Ω-gain block
- 3 dB-bandwidth: DC to 2.8 GHz with 17.5 dB typical gain at 1.0 GHz
- Compression point P_{-1dB} = 7 dBm at 2.0 GHz
- Noise figure $F_{50\Omega}$ = 2.1 dB at 2 GHz
- · Absolute stable
- 70 GHz f_T Silicon Germanium technology
- 1 kV HBM ESD protection (Pin-to-Pin)
- Pb-free (RoHS compliant) package





Applications

- Driver amplifier for GSM/PCS/CDMA/UMTS
- Broadband amplifier for SAT-TV & LNBs
- · Broadband amplifier for CATV

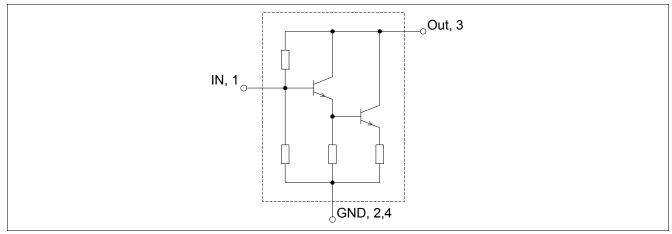


Figure 1 Pin connection

Description

BGA612 is a broadband matched, general purpose MMIC amplifier in a Darlington configuration. It is optimized for a typical supply current of 20 mA.

The BGA612 is based on Infineon Technologies' B7HF Silicon Germanium technology.

Туре	Package	Marking
BGA612	SOT343	BNs

Note: **ESD:** Electrostatic discharge sensitive device, observe handling precaution



Electrical Characteristics

Maximum Ratings

Table 1 Maximum ratings

Parameter	Symbol	Limit Value	Unit
Device voltage	V_{D}	2.8	V
Device current	I_{D}	80	mA
Current into pin In	I_{in}	0.7	mA
Input power ¹⁾	P_{in}	10	dBm
Total power dissipation, $T_{\rm S}$ < 105 °C ²⁾	P_{tot}	225	mW
Junction temperature	T_{J}	150	°C
Ambient temperature range	T_{A}	-65 150	°C
Storage temperature range	T_{STG}	-65 150	°C
ESD capability all pins (HBM: JESD22-A114)	V _{ESD}	1000	V

¹⁾ Valid for $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω , $V_{\rm CC}$ = 5 V, $R_{\rm Bias}$ = 135 Ω

Note: All Voltages refer to GND-Node

Thermal resistance

Table 2 Thermal resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R_{thJS}	200	K/W

¹⁾ For calculation of $R_{\mathrm{th,IA}}$ please refer to Application Note Thermal Resistance

2 Electrical Characteristics

Electrical characteristics at $T_{\rm A}$ = 25 °C (measured in test circuit specified in **Figure 2**) $V_{\rm CC}$ = 5 V, $R_{\rm Bias}$ = 135 Ω , Frequency = 2 GHz, unless otherwise specified

Table 3 Electrical Characteristics

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		Test Condition
Insertion power gain	$ S_{21} ^2$		18.0		dB	f = 0.1 GHz
			17.5		dB	f = 1.0 GHz
			16.3		dB	f = 2.0 GHz
Noise figure ($Z_{\rm S}$ = 50 Ω)	$F_{50\Omega}$		1.8		dB	f = 0.1 GHz
			2.0		dB	f = 1.0 GHz
			2.1		dB	f = 2.0 GHz
Output power at 1 dB gain compression	$P_{ ext{-1dB}}$		7		dBm	
Output third order intercept point	OIP_3		17		dBm	
Input return loss	RL_{in}		17		dB	
Output return loss	RL_{out}		17		dB	
Total device current	I_{D}		20		mA	

²⁾ $\ensuremath{\mathit{T}_{\mathrm{S}}}$ is measured on the ground lead at the soldering point



Electrical Characteristics

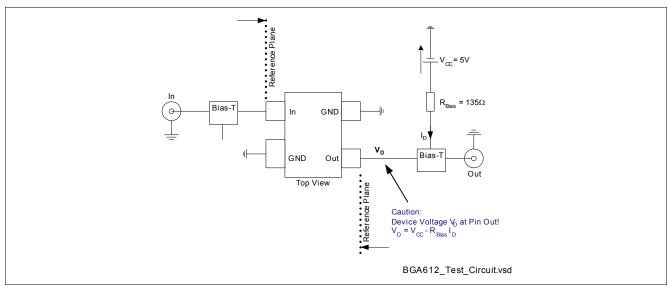
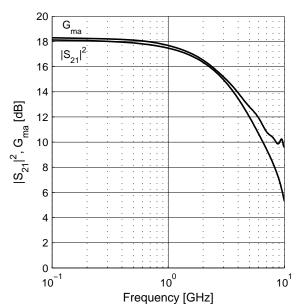


Figure 2 Test Circuit for Electrical Characteristics and S-Parameter

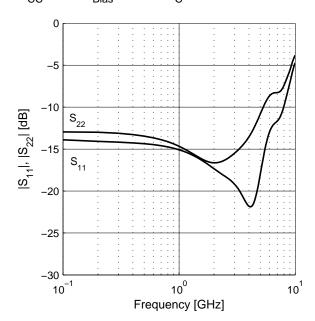
Measured Parameters

3 Measured Parameters

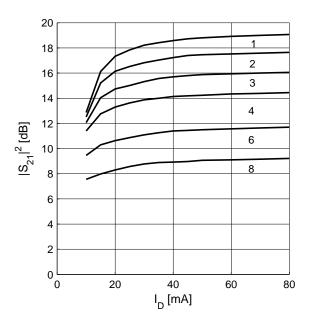
Power Gain
$$|S_{21}|^2$$
, $G_{ma} = f(f)$
 $V_{CC} = 5V$, $R_{Bias} = 135Ω$, $I_{C} = 20mA$



$$\begin{aligned} & \textbf{Matching} \; |\textbf{S}_{11}|, \; |\textbf{S}_{22}| = \textbf{f(f)} \\ & \textbf{V}_{CC} = \textbf{5V}, \; \textbf{R}_{Bias} = \textbf{135}\Omega, \; \textbf{I}_{\;C} = \textbf{20mA} \end{aligned}$$

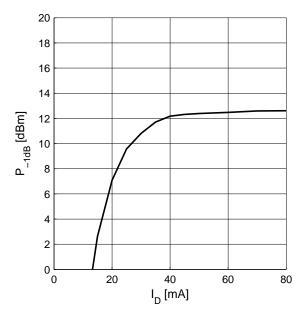


Power Gain $|S_{21}| = f(I_D)$ f = parameter in GHz



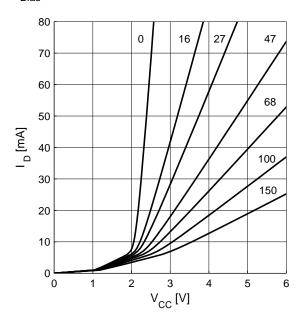
Output Compression Point

$$P_{-1dB} = f(I_D), f = 2GHz$$

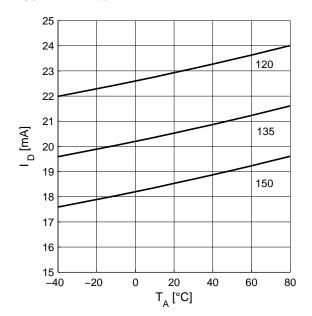




Measured Parameters

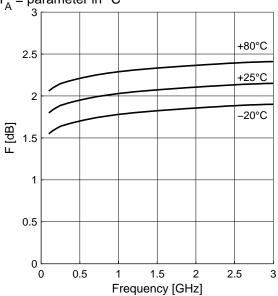


Device Current I
$$_{\rm D}$$
 = f(T $_{\rm A}$)
V $_{\rm CC}$ = 5V, R $_{\rm Bias}$ = parameter in Ω



Noise figure F = f(f)

$$V_{CC} = 5V$$
, $R_{Bias} = 135\Omega$, $Z_{S} = 50\Omega$
 $T_{A} = parameter in °C$





Package Information

4 Package Information

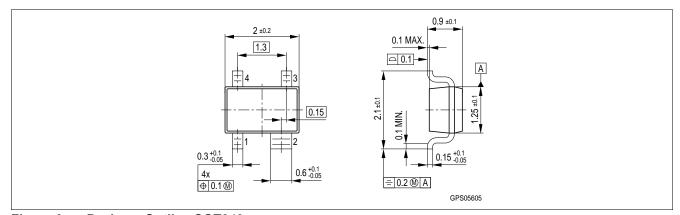


Figure 3 Package Outline SOT343

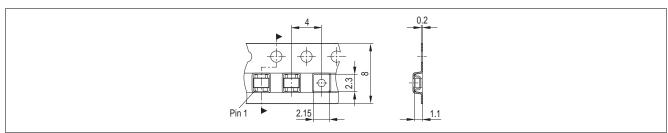


Figure 4 Tape for SOT343

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF Amplifier category:

Click to view products by Infineon manufacturer:

Other Similar products are found below:

A82-1 BGA622H6820XTSA1 BGA 728L7 E6327 BGB719N7ESDE6327XTMA1 HMC397-SX HMC405 HMC561-SX HMC8120-SX HMC8121-SX HMC-ALH382-SX HMC-ALH476-SX SE2433T-R SMA3101-TL-E SMA39 A66-1 A66-3 A67-1 LX5535LQ LX5540LL MAAM02350 HMC3653LP3BETR HMC549MS8GETR HMC-ALH435-SX SMA101 SMA32 SMA411 SMA531 SST12LP17E-XX8E SST12LP19E-QX6E WPM0510A HMC5929LS6TR HMC5879LS7TR HMC1126 HMC1087F10 HMC1086 HMC1016 SMA1212 MAX2689EWS+T MAAMSS0041TR MAAM37000-A1G LTC6430AIUF-15#PBF CHA5115-QDG SMA70-2 SMA4011 A231 HMC-AUH232 LX5511LQ LX5511LQ-TR HMC7441-SX HMC-ALH310